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Date: October 27, 2005

By: \_\_\_\_\_

Maureen Golob

PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

ADAMS, ET AL.,

APPLICATION/PATENT No.: 10/648,407

FILED/ISSUED: AUGUST 25, 2003

FOR: INTERCONNECT FOR ELECTRICALLY  
CONNECTING A MULTICHIP MODULE  
TO A CIRCUIT SUBSTRATE AND  
PROCESSES FOR MAKING AND USING  
SAME

ATTORNEY DOCKET No.: 58689-8074.US02

EXAMINER: GILMAN, ALEXANDER

ART UNIT: 2833

CONFIRMATION: 4026

Change of Address

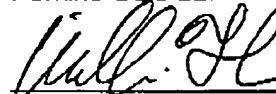
Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Effective immediately, please direct all further communications in the above-identified patent application to the following address which is associated with customer number: 57284.

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